

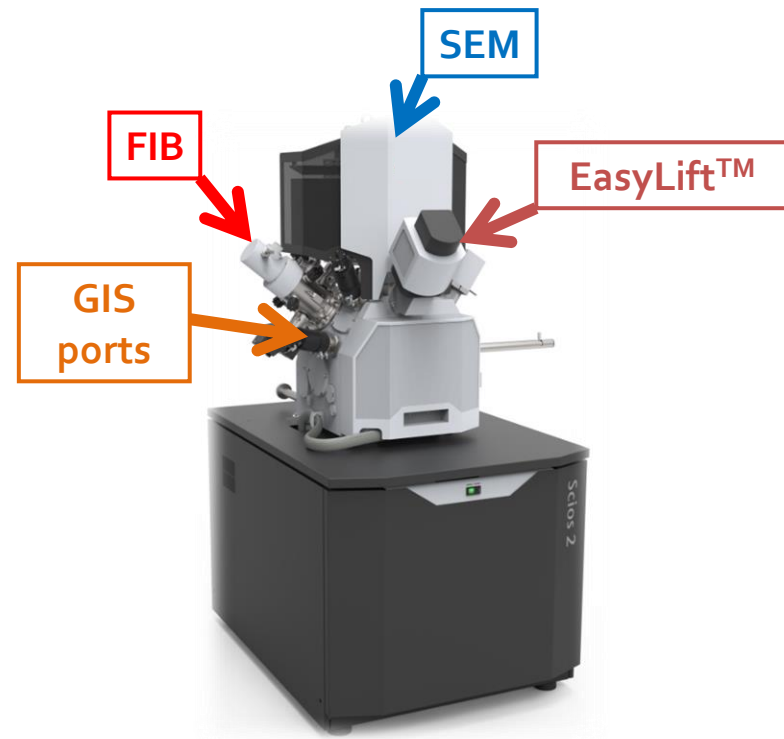
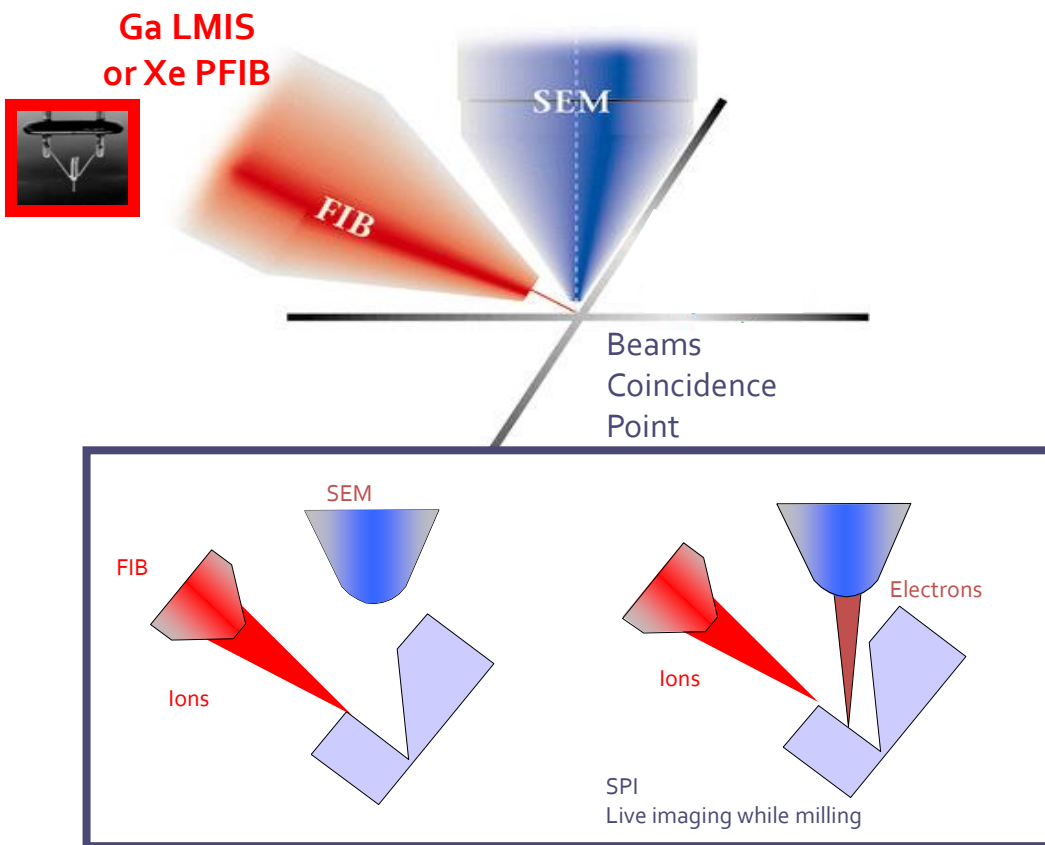
Dual Beam at BGU, capabilities for 3D Nano-scale Materials Characterization



- DualBeam™ overview
- Helios G4 UC
 - SEM - Electron column – Elstar UC+
 - FIB - Ion column – Tomahawk
 - Stage; easylift; multichem; EDX
- Applications:
 - cut and view
 - Site-specific material biopsy: TEM lamella preparation, Atom probe sample preparation, STEM imaging and analysis
 - Nano patterning
 - 3D slicing and tomography
 - Automation

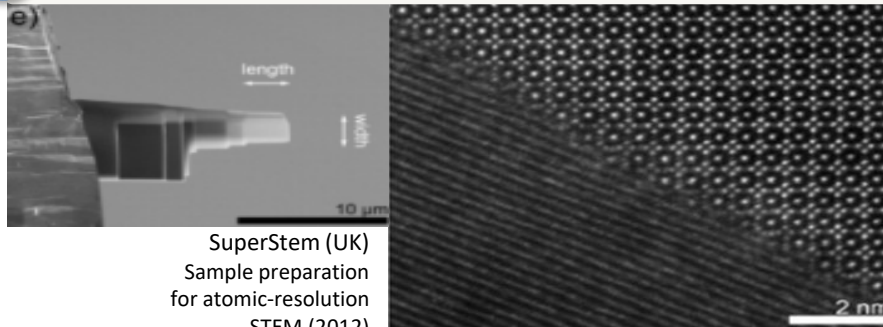


DualBeam™ Overview



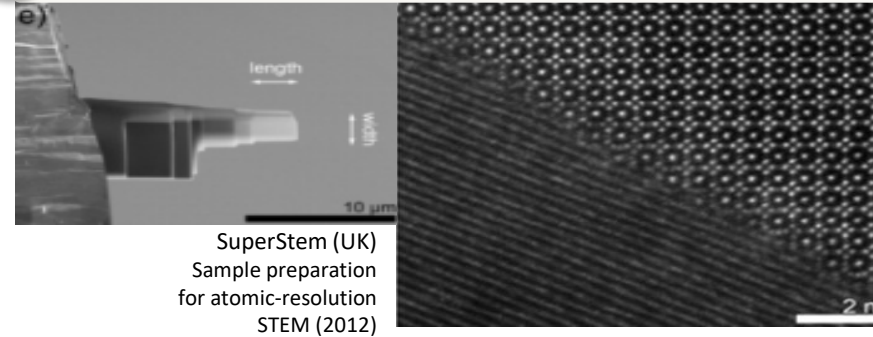
1

Cut and view



2

Site-specific material biopsy



3

Nano patterning

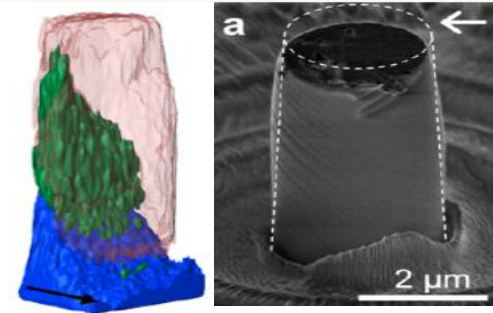
Aalto Univ (FI),
Ion-beam assisted self-assembly of
metallic nanostructures (2012)



4

3D slicing and tomography

Cambridge Univ. (UK)
3D EBSD analysis of deformation in
MgO micropillars (2011)



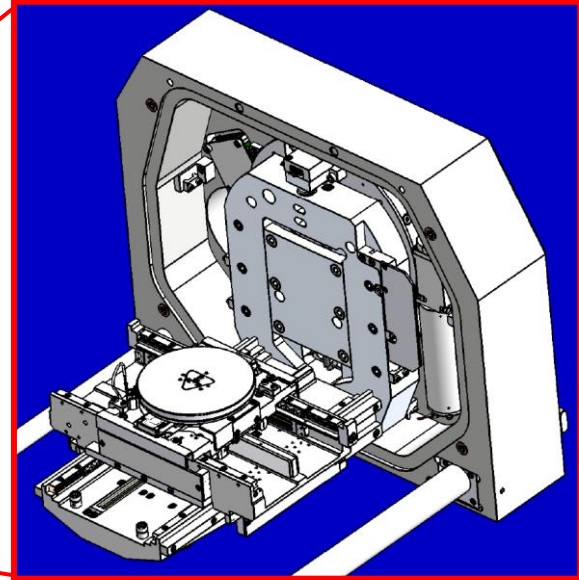
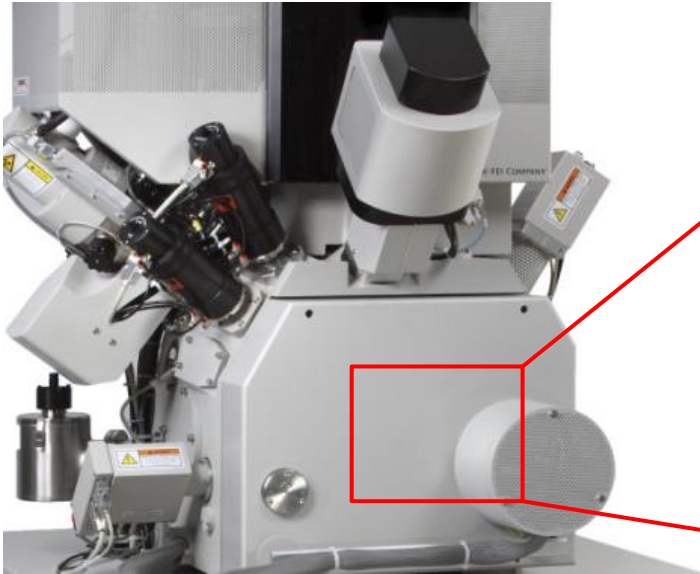
Helios G4 UC – Specifications

SEM	Column technology	Elstar™ UC+ with BD		
	Resolution	0.6 nm @ 2 keV	0.7 nm @ 1 keV	1.0 nm @ 500 eV
	Landing voltage range	20 eV – 30 keV		
	E-beam current range	0.8 pA – 100 nA		
FIB	Column technology	Tomahawk (differential pumping, TOF)		
	30kV resolution	2.5 nm using selective edge method		
	I-beam current range	0.1pA – 65 nA		
Detection	Standard detectors	ETD, TLD (SE/BSE), MD (BSE), ICD (SE/BSE)		
Stage	Type	High precision 5-axis motorized , with X-Y-R axis piezo driven		
	X-Y-Z Range	150x150x10 mm (max Z clearance 55 mm to eucentric point)		
	Tilt Range / Rotation	-10° to +60° / 360° endless		
Supporting HW and SW	Navigation	In-chamber Nav-Cam, IR camera, Image registration		
	Process monitoring	SPI, iSPI, iRTM, FIB immersion		
	Scan strategies	SmartScan™, Interlaced Scanning, DCFI		
	Sample cleanliness	Integrated Plasma Cleaner		



Stage - Consistently preparing high quality samples

Large, ultra-stable, accurate and repeatable piezo stage



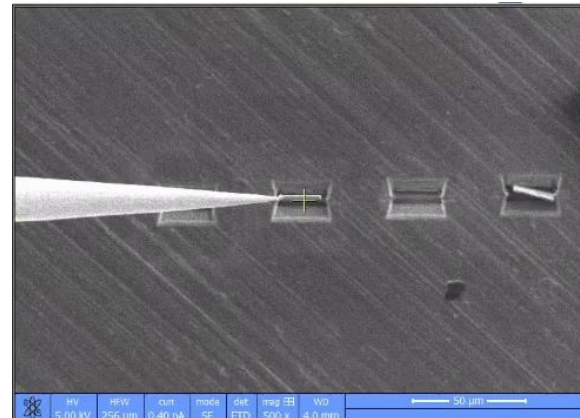
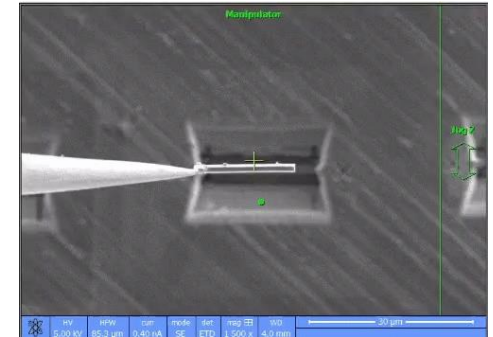
- X-Y-Z range: 150x150x10 mm
- Clearance 55mm to eucentric point
- Rotation: 360° (endless)

- Tilt range: -10° to +60°
- XY repeatability: 1 μ m

EasyLift - provides computer controlled accurate movement for lift-out

Thermo Fisher **EasyLift**

- Integrated & intuitive controls
- Stable & reliable operation
- Precise and repeatable motion

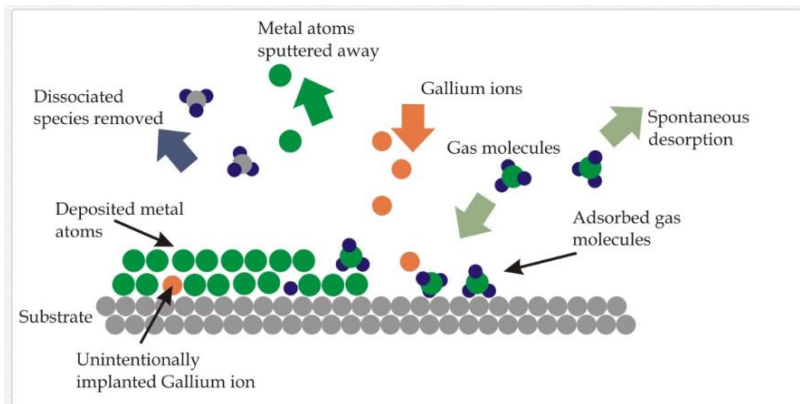
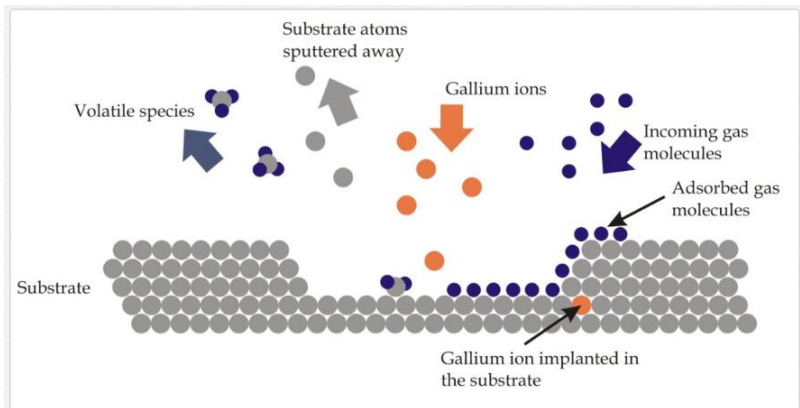


Consistently preparing high quality samples with EasyLift - fully integrated in-situ lift-out (INLO) solution

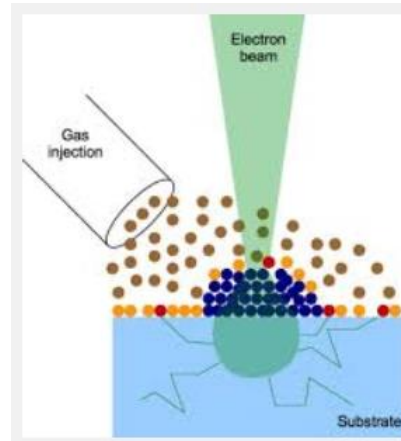
Multichem - provides computer controlled accurate movement for lift-out

- Up to 6 different precursors are available with one injection nozzle.
- Allow chemical deposition or etch in addition to the ion physical sputter.

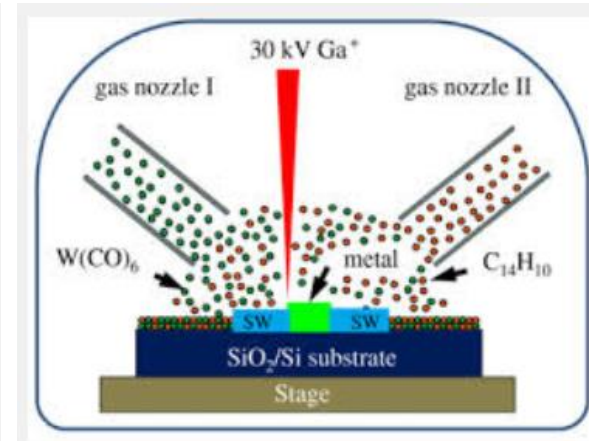
Gas enhance



e beam



I beam



Helios G4 UC - Enabling breakthrough innovations with DualBeam™ — faster and easier than ever before



- **Fast and easy preparation** of high quality samples for HR S/TEM and APT
- **Extreme high resolution imaging** with the most precise contrast
- **Access highest resolution**, multi-scale and multi-modal subsurface and 3D information
- **Fast, accurate, and precise milling and deposition** of complex structures with critical dimensions of less than 10 nm